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#### What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

## Details

2 0 0 0 0 0	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I <sup>2</sup> C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	33
Program Memory Size	14KB (8K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	368 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-QFP
Supplier Device Package	44-MQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c67t-20i-pq

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

## 2.0 PIC16C6X DEVICE VARIETIES

A variety of frequency ranges and packaging options are available. Depending on application and production requirements, the proper device option can be selected using the information in the PIC16C6X Product Identification System section at the end of this data sheet. When placing orders, please use that page of the data sheet to specify the correct part number.

For the PIC16C6X family of devices, there are four device "types" as indicated in the device number:

- 1. **C**, as in PIC16**C**64. These devices have EPROM type memory and operate over the standard voltage range.
- 2. LC, as in PIC16LC64. These devices have EPROM type memory and operate over an extended voltage range.
- 3. **CR**, as in PIC16**CR**64. These devices have ROM program memory and operate over the standard voltage range.
- 4. LCR, as in PIC16LCR64. These devices have ROM program memory and operate over an extended voltage range.

### 2.1 UV Erasable Devices

The UV erasable version, offered in CERDIP package is optimal for prototype development and pilot programs. This version can be erased and reprogrammed to any of the oscillator modes.

Microchip's PICSTART<sup>®</sup> Plus and PRO MATE<sup>®</sup> II programmers both support programming of the PIC16C6X.

#### 2.2 <u>One-Time-Programmable (OTP)</u> <u>Devices</u>

The availability of OTP devices is especially useful for customers who need the flexibility for frequent code updates and small volume applications.

The OTP devices, packaged in plastic packages, permit the user to program them once. In addition to the program memory, the configuration bits must also be programmed.

### 2.3 <u>Quick-Turnaround-Production (QTP)</u> <u>Devices</u>

Microchip offers a QTP Programming Service for factory production orders. This service is made available for users who choose not to program a medium to high quantity of units and whose code patterns have stabilized. The devices are identical to the OTP devices but with all EPROM locations and configuration options already programmed by the factory. Certain code and prototype verification procedures apply before production shipments are available. Please contact your local Microchip Technology sales office for more details.

### 2.4 <u>Serialized Quick-Turnaround</u> <u>Production (SQTP<sup>SM</sup>) Devices</u>

Microchip offers a unique programming service where a few user-defined locations in each device are programmed with different serial numbers. The serial numbers may be random, pseudo-random, or sequential.

Serial programming allows each device to have a unique number which can serve as an entry-code, password, or ID number.

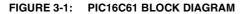
ROM devices do not allow serialization information in the program memory space. The user may have this information programmed in the data memory space.

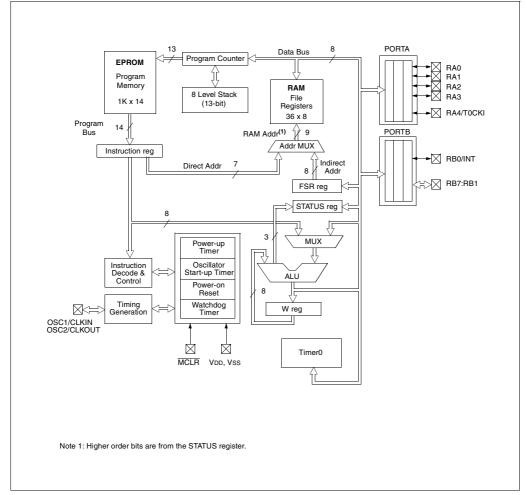
For information on submitting ROM code, please contact your regional sales office.

## 2.5 Read Only Memory (ROM) Devices

Microchip offers masked ROM versions of several of the highest volume parts, thus giving customers a low cost option for high volume, mature products.

For information on submitting ROM code, please contact your regional sales office.





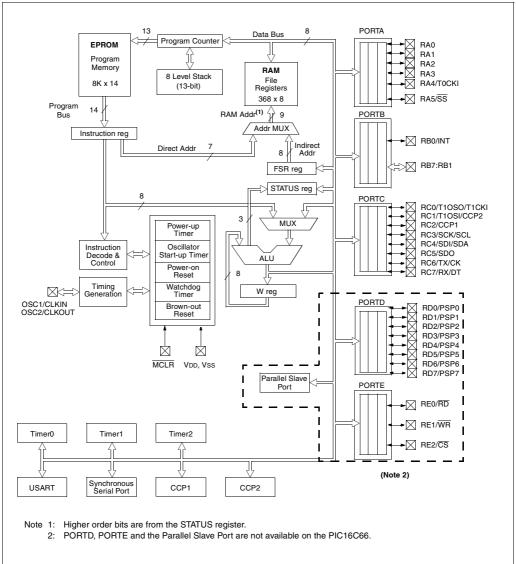


FIGURE 3-4: PIC16C66/67 BLOCK DIAGRAM

#### 4.2.2.3 INTCON REGISTER

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The INTCON Register is a readable and writable register which contains the various enable and flag bits for the TMR0 register overflow, RB port change and external RB0/INT pin interrupts.

#### Note: Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>).

### FIGURE 4-11: INTCON REGISTER (ADDRESS 0Bh, 8Bh, 10Bh 18Bh)

R/W-0 GIE	R/W-0 PEIE	R/W-0 T0IE	R/W-0 INTE	R/W-0 RBIE	R/W-0 T0IF	R/W-0 INTF	R/W-x RBIF	R = Readable bit				
bit7	1 212	TOLE	INTE	TIDIL	1011		bit0	W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset x = unknown				
bit 7:	GIE: <sup>(1)</sup> Global Interrupt Enable bit 1 = Enables all un-masked interrupts 0 = Disables all interrupts											
bit 6:	PEIE: <sup>(2)</sup> Peripheral Interrupt Enable bit 1 = Enables all un-masked peripheral interrupts 0 = Disables all peripheral interrupts											
bit 5:		s the TMR	Interrupt E 0 overflow ii 0 overflow i	nterrupt								
bit 4:	1 = Enable	s the RB0/	nal Interrup INT externa INT externa									
bit 3:		s the RB p	e Interrupt ort change ort change	interrupt								
bit 2:	<b>TOIF:</b> TMR 1 = TMR0 0 = TMR0	register ove	erflowed (m	ust be cleai	red in softwa	re)						
bit 1:		30/INT exte	rnal interru		(must be cle ccur	ared in soft	ware)					
bit 0:	<b>RBIF:</b> RB Port Change Interrupt Flag bit         1 = At least one of the RB7:RB4 pins changed state (see Section 5.2 to clear the interrupt)         0 = None of the RB7:RB4 pins have changed state											
	: For the PIC16C61/62/64/65, if an interrupt occurs while the GIE bit is being cleared, the GIE bit may unintentionally be re-enabled by the RETFIE instruction in the user's Interrupt Service Routine. Refer to Section 13.5 for a detailed description.											
	The PEIE I	bit (bit6) is			PIC16C61, r							
globa		GIE (INTC						corresponding enable bit or the rupt flag bits are clear prior to				

#### 4.2.2.4 PIE1 REGISTER

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

This register contains the individual enable bits for the peripheral interrupts.

Bit PEIE (INTCON<6>) must be set to Note: enable any peripheral interrupt.

## FIGURE 4-12: PIE1 REGISTER FOR PIC16C62/62A/R62 (ADDRESS 8Ch)

RW-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0						
_	—		_	SSPIE	CCP1IE	TMR2IE	TMR1IE	R = Readable bit					
bit7							bit0	<ul> <li>W = Writable bit</li> <li>U = Unimplemented bit, read as '0'</li> <li>n = Value at POR reset</li> </ul>					
bit 7-6:	Reserved:	Reserved: Always maintain these bits clear.											
bit 5-4:	Unimplem	ented: Rea	ıd as '0'										
bit 3:	SSPIE: Synchronous Serial Port Interrupt Enable bit 1 = Enables the SSP interrupt 0 = Disables the SSP interrupt												
bit 2:	<b>CCP1IE</b> : C 1 = Enables 0 = Disable	s the CCP1	interrupt	bit									
bit 1:	<b>TMR2IE</b> : TMR2 to PR2 Match Interrupt Enable bit 1 = Enables the TMR2 to PR2 match interrupt 0 = Disables the TMR2 to PR2 match interrupt												
bit 0:	TMR1IE: TMR1 Overflow Interrupt Enable bit         1 = Enables the TMR1 overflow interrupt         0 = Disables the TMR1 overflow interrupt												

## FIGURE 4-15: PIE1 REGISTER FOR PIC16C65/65A/R65/67 (ADDRESS 8Ch)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
PSPIE	—	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	R = Readable bit
bit7							bit0	W = Writable bit
								U = Unimplemented bit,
								read as '0'
								- n = Value at POR reset
bit 7:	1 = Enable				upt Enable b	bit		
	0 = Disable							
1.1.0				•				
bit 6:	Reserved:	Always ma	aintain this	oit clear.				
bit 5:	RCIE: USA							
	1 = Enable							
	0 = Disable			•				
bit 4:	TXIE: USA							
	1 = Enable							
	0 = Disable			•				
bit 3:	SSPIE: Syr			Interrupt Er	nable bit			
	1 = Enable							
	0 = Disable		•					
bit 2:	CCP1IE: C			bit				
	1 = Enable							
	0 = Disable		•					
bit 1:	TMR2IE: T							
	1 = Enable							
	0 = Disable				•			
bit 0:	TMR1IE: T				it			
	1 = Enable							
	0 = Disable	s the TMR	I OVERTION	nterrupt				

#### 5.4 PORTD and TRISD Register

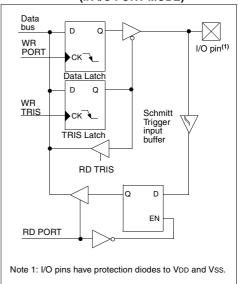
## Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

PORTD is an 8-bit port with Schmitt Trigger input buffers. Each pin is individually configurable as input or output.

PORTD can be configured as an 8-bit wide microprocessor port (parallel slave port) by setting control bit PSPMODE (TRISE<4>). In this mode, the input buffers are TTL.

#### FIGURE 5-7: PORTD BLOCK DIAGRAM (IN I/O PORT MODE)



Name	Bit#	Buffer Type	Function
RD0/PSP0	bit0	ST/TTL <sup>(1)</sup>	Input/output port pin or parallel slave port bit0
RD1/PSP1	bit1	ST/TTL <sup>(1)</sup>	Input/output port pin or parallel slave port bit1
RD2/PSP2	bit2	ST/TTL <sup>(1)</sup>	Input/output port pin or parallel slave port bit2
RD3/PSP3	bit3	ST/TTL <sup>(1)</sup>	Input/output port pin or parallel slave port bit3
RD4/PSP4	bit4	ST/TTL <sup>(1)</sup>	Input/output port pin or parallel slave port bit4
RD5/PSP5	bit5	ST/TTL <sup>(1)</sup>	Input/output port pin or parallel slave port bit5
RD6/PSP6	bit6	ST/TTL <sup>(1)</sup>	Input/output port pin or parallel slave port bit6
RD7/PSP7	bit7	ST/TTL <sup>(1)</sup>	Input/output port pin or parallel slave port bit7

## TABLE 5-9: PORTD FUNCTIONS

Legend: ST = Schmitt Trigger input, TTL = TTL input Note 1: Buffer is a Schmitt Trigger when in I/O mode, and a TTL buffer when in Parallel Slave Port mode.

### TABLE 5-10: SUMMARY OF REGISTERS ASSOCIATED WITH PORTD

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
08h	PORTD	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	xxxx xxxx	uuuu uuuu
88h	TRISD	PORTD Data Direction Register								1111 1111	1111 1111
89h	TRISE	IBF	OBF	IBOV	PSPMODE	_	PORTE Da	ata Directio	n Bits	0000 -111	0000 -111

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by PORTD.

## TABLE 5-11: PORTE FUNCTIONS

Name	Bit#	Buffer Type	Function
RE0/RD	bit0	ST/TTL <sup>(1)</sup>	Input/output port pin or Read control input in parallel slave port mode. RD 1 = Not a read operation 0 = Read operation. The system reads the PORTD register (if chip selected)
RE1/WR	bit1	ST/TTL <sup>(1)</sup>	Input/output port pin or Write control input in parallel slave port mode. WR 1 = Not a write operation 0 = Write operation. The system writes to the PORTD register (if chip selected)
RE2/CS	bit2	ST/TTL <sup>(1)</sup>	Input/output port pin or Chip select control input in parallel slave port mode. CS 1 = Device is not selected 0 = Device is selected

Legend: ST = Schmitt Trigger input, TTL = TTL input

Note 1: Buffer is a Schmitt Trigger when in I/O mode, and a TTL buffer when in Parallel Slave Port (PSP) mode.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
09h	PORTE		—	_	—		RE2	RE1	RE0	xxx	uuu
89h	TRISE	IBF	OBF	IBOV	PSPMODE	_	PORTE Data Direction Bits		0000 -111	0000 -111	

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells not used by PORTE.

#### 10.3 PWM Mode

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

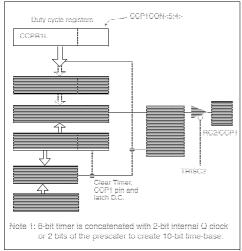
In Pulse Width Modulation (PWM) mode, the CCP1 pin produces up to a 10-bit resolution PWM output. Since the CCP1 pin is multiplexed with the PORTC data latch, the TRISC<2> bit must be cleared to make the CCP1 pin an output.

Note: Clearing the CCP1CON register will force the CCP1 PWM output latch to the default low level. This is not the PORTC I/O data latch.

Figure 10-4 shows a simplified block diagram of the CCP module in PWM mode.

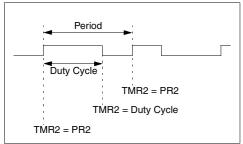
For a step by step procedure on how to set up the CCP module for PWM operation, see Section 10.3.3.

#### FIGURE 10-4: SIMPLIFIED PWM BLOCK DIAGRAM



A PWM output (Figure 10-5) has a time base (period) and a time that the output stays high (duty cycle). The frequency of the PWM is the inverse of the period (1/period).

#### FIGURE 10-5: PWM OUTPUT



#### 10.3.1 PWM PERIOD

The PWM period is specified by writing to the PR2 register. The PWM period can be calculated using the following formula:

PWM period = [(PR2) + 1] • 4 • TOSC • (TMR2 prescale value)

PWM frequency is defined as 1 / [PWM period].

When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

- TMR2 is cleared
- The PWM duty cycle is latched from CCPR1L into CCPR1H
- The CCP1 pin is set (exception: if PWM duty cycle = 0%, the CCP1 pin will not be set)

Note:	The Timer2 postscaler (see Section 9.1) is						
	not used in the determination of the PWM						
frequency. The postscaler could be used							
	have a servo update rate at a different fre-						
	quency than the PWM output.						

#### 10.3.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing to the CCPR1L register and to the CCP1CON<5:4> bits. Up to 10-bit resolution is available: the CCPR1L contains the eight MSbs and the CCP1CON<5:4> contains the two LSbs. This 10-bit value is represented by CCPR1L:CCP1CON<5:4>. The following equation is used to calculate the PWM duty cycle in time:

#### PWM duty cycle = (CCPR1L:CCP1CON<5:4>) • Tosc • (TMR2 prescale value)

CCPR1L and CCP1CON<5:4> can be written to at any time, but the duty cycle value is not latched into CCPR1H until after a match between PR2 and TMR2 occurs (i.e., the period is complete). In PWM mode, CCPR1H is a read-only register.

The CCPR1H register and a 2-bit internal latch are used to double buffer the PWM duty cycle. This double buffering is essential for glitchless PWM operation.

When the CCPR1H and 2-bit latch match TMR2 concatenated with an internal 2-bit Q clock or 2 bits of the TMR2 prescaler, the CCP1 pin is cleared.

Maximum PWM resolution (bits) for a given PWM frequency:

$$= \frac{\log\left(\frac{FOSC}{FPWM}\right)}{\log(2)} \quad \text{bits}$$

Note: If the PWM duty cycle value is longer than the PWM period the CCP1 pin will not be forced to the low level.

#### 12.2.2 USART ASYNCHRONOUS RECEIVER

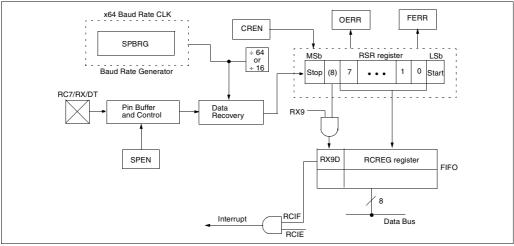
The receiver block diagram is shown in Figure 12-10. The data comes in the RC7/RX/DT pin and drives the data recovery block. The data recovery block is actually a high speed shifter operating at x16 times the baud rate, whereas the main receive serial shifter operates at the bit rate or at FOSC.

Once Asynchronous mode is selected, reception is enabled by setting bit CREN (RCSTA<4>).

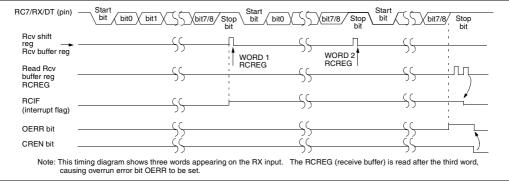
The heart of the receiver is the receive (serial) shift register (RSR). After sampling the STOP bit, the received data in the RSR is transferred to the RCREG register (if it is empty). If the transfer is complete, flag bit RCIF (PIR1<5>) is set. The actual interrupt can be enabled/disabled by setting/clearing enable bit RCIE (PIE1<5>). Flag bit RCIF is a read only bit which is cleared by the hardware. It is cleared when the RCREG register has been read and is empty. The RCREG is double buffered register, i.e., it is a two deep FIFO. It is

#### FIGURE 12-10: USART RECEIVE BLOCK DIAGRAM

possible for two bytes of data to be received and transferred to the RCREG FIFO and a third byte begin shifting to the RSR register. On the detection of the STOP bit of the third byte, if the RCREG is still full, then the overrun error bit, OERR (RCSTA<1>) will be set. The word in the RSR register will be lost. The RCREG register can be read twice to retrieve the two bytes in the FIFO. Overrun bit OERR has to be cleared in software. This is done by resetting the receive logic (CREN is cleared and then set). If bit OERR is set, transfers from the RSR register to the RCREG register are inhibited, so it is essential to clear overrun bit OERR if it is set. Framing error bit FERR (RCSTA<2>) is set if a stop bit is detected as clear. Error bit FERR and the 9th receive bit are buffered the same way as the receive data. Reading the RCREG register will load bits RX9D and FERR with new values. Therefore it is essential for the user to read the RCSTA register before reading RCREG in order not to lose the old FERR and RX9D information.



#### FIGURE 12-11: ASYNCHRONOUS RECEPTION



Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

## 17.0 ELECTRICAL CHARACTERISTICS FOR PIC16C62/64

#### Absolute Maximum Ratings †

5500 L 0500
55°C to +85°C
65°C to +150°C
-0.3V to +7.5V
0V to +14V
0V to +14V
1.0W
250 mA
±20 mA
±20 mA
25 mA
25 mA
200 mA
200 mA
200 mA
200 mA

Note 1: Power dissipation is calculated as follows: Pdis = VDD x { $DD - \sum DH$  +  $\sum {(VDD-VOH) x IOH} + \sum (VOI x IOL)$ 

Note 2: Voltage spikes below Vss at the MCLR pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the MCLR pin rather than pulling this pin directly to Vss.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

## TABLE 17-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

osc	PIC16C62-04 PIC16C64-04	PIC16C62-10 PIC16C64-10	PIC16C62-20 PIC16C64-20	PIC16LC62-04 PIC16LC64-04	JW Devices
RC	VDD: 4.0V to 6.0V IDD: 3.8 mA max. at 5.5V IPD: 21 μA max. at 4V Freq:4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq:4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq:4 MHz max.	VDD: 3.0V to 6.0V IDD: 3.8 mA max. at 3.0V IPD: 13.5 μA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 3.8 mA max. at 5.5V IPD: 21 μA max. at 4V Freq:4 MHz max.
XT	VDD: 4.0V to 6.0V IDD: 3.8 mA max. at 5.5V IPD: 21 μA max. at 4V Freq:4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq:4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq:4 MHz max.	VDD: 3.0V to 6.0V IDD: 3.8 mA max. at 3.0V IPD: 13.5 μA max. at 3.0V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 3.8 mA max. at 5.5V IPD: 21 μA max. at 4V Freq:4 MHz max.
HS	VDD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V IPD: 1.5 μA typ. at 4.5V Freq:4 MHz max.	VDD: 4.5V to 5.5V IDD: 15 mA max. at 5.5V IPD: 1.5 μA typ. at 4.5V Freq: 10 MHz max.	VDD: 4.5V to 5.5V IDD: 30 mA max. at 5.5V IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 30 mA max. at 5.5V IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.
LP	VDD: 4.0V to 6.0V IDD: 52.5 μA typ. at 32 kHz, 4.0V IPD: 0.9 μA typ. at 4.0V Freq:200 kHz max.	Not recommended for use in LP mode	Not recommended for use in LP mode	VDD: 3.0V to 6.0V IDD: 48 μA max. at 32 kHz, 3.0V IPD: 13.5 μA max. at 3.0V Freq:200 kHz max.	VDD: 3.0V to 6.0V IDD: 48 μA max. at 32 kHz, 3.0V IPD:13.5 μA max. at 3.0V Freq:200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

## 18.0 ELECTRICAL CHARACTERISTICS FOR PIC16C62A/R62/64A/R64

#### Absolute Maximum Ratings †

Ambient temperature under bias	55°C to +125°C
Storage temperature	65°C to +150°C
Voltage on any pin with respect to Vss (except VDD, MCLR, and RA4)	0.3V to (VDD + 0.3V)
Voltage on VDD with respect to VSS	-0.3V to +7.5V
Voltage on MCLR with respect to Vss (Note 2)	0V to +14V
Voltage on RA4 with respect to Vss	0V to +14V
Total power dissipation (Note 1)	1.0W
Maximum current out of VSS pin	
Maximum current into VDD pin	250 mA
Input clamp current, Iк (VI < 0 or VI > VDD)	±20 mA
Output clamp current, loк (Vo < 0 or Vo > VDD)	±20 mA
Maximum output current sunk by any I/O pin	25 mA
Maximum output current sourced by any I/O pin	25 mA
Maximum current sunk by PORTA, PORTB, and PORTE (combined)	200 mA
Maximum current sourced by PORTA, PORTB, and PORTE (combined)	200 mA
Maximum current sunk by PORTC and PORTD (combined)	200 mA
Maximum current sourced by PORTC and PORTD (combined)	200 mA
Note 1: Power dissipation is calculated as follows: $Pdis = Vop \times (Iop - \sum Iou) + \sum (Vop$	$V(\alpha u) \times I(\alpha u) + \Sigma(V(\alpha v (\alpha u)))$

**Note 1:** Power dissipation is calculated as follows: Pdis = VDD x {IDD -  $\sum$  IOH} +  $\sum$  {(VDD-VOH) x IOH} +  $\sum$ (VOI x IOL)

Note 2: Voltage spikes below Vss at the MCLR pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the MCLR pin rather than pulling this pin directly to Vss.

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#### TABLE 18-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

osc	PIC16C62A-04 PIC16CR62-04 PIC16C64A-04 PIC16CR64-04	PIC16C62A-10 PIC16CR62-10 PIC16C64A-10 PIC16CR64-10	PIC16C62A-20 PIC16CR62-20 PIC16C64A-20 PIC16CR64-20	PIC16LC62A-04 PIC16LCR62-04 PIC16LC64A-04 PIC16LCR64-04	JW Devices
RC	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq:4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3.0V IPD: 5 μA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq:4 MHz max.
ХТ	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3.0V IPD: 5 µA max. at 3.0V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.
HS	VpD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V IPD: 1.5 μA typ. at 4.5V Freq: 4 MHz max.		VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.
LP	VDD: 4.0V to 6.0V IDD: 52.5 μA typ. at 32 kHz, 4.0V IPD: 0.9 μA typ. at 4.0V Freq: 200 kHz max.	Not recommended for use in LP mode	Not recommended for use in LP mode	VDD: 2.5V to 6.0V IDD: 48 μA max. at 32 kHz, 3.0V IPD: 5 μA max. at 3.0V Freq: 200 kHz max.	VDD: 2.5V to 6.0V IDD: 48 μA max. at 32 kHz, 3.0V IPD: 5 μA max. at 3.0V Freq: 200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

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### 18.1 DC Characteristics: PIC16C62A/R62/64A/R64-04 (Commercial, Industrial, Extended) PIC16C62A/R62/64A/R64-10 (Commercial, Industrial, Extended) PIC16C62A/R62/64A/R64-20 (Commercial, Industrial, Extended)

DC CHA		<b>Standar</b> Operatir			ə -40	)°C ≤	unless otherwise stated) $TA \le +125^{\circ}C$ for extended,
			$\leq$ TA $\leq$ +85°C for industrial and $\leq$ TA $\leq$ +70°C for commercial				
Param No.	Characteristic	Sym	Min	Тур†	Max	Units	Conditions
D001 D001A	Supply Voltage	Vdd	4.0 4.5	-	6.0 5.5	V V	XT, RC and LP osc configuration HS osc configuration
D002*	RAM Data Retention Voltage (Note 1)	Vdr	-	1.5	-	V	
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details
D005	Brown-out Reset Voltage	Bvdd	3.7	4.0	4.3	V	BODEN bit in configuration word enabled
			3.7	4.0	4.4	v	Extended Range Only
D010	Supply Current (Note 2, 5)	Idd	-	2.7	5	mA	XT, RC, osc configuration Fosc = 4 MHz, VDD = 5.5V (Note 4)
D013			-	10	20	mA	HS osc configuration FOSC = 20 MHz, VDD = 5.5V
D015*	Brown-out Reset Current (Note 6)	$\Delta$ Ibor	-	350	425	μA	BOR enabled, VDD = 5.0V
D020	Power-down Current (Note	IPD	-	10.5	42	μA	VDD = 4.0V, WDT enabled, -40°C to +85°C
D021	3, 5)		-	1.5	16	μA	VDD = 4.0V, WDT disabled, $-0^{\circ}C$ to $+70^{\circ}C$
D021A			-	1.5 2.5	19	μA	$V_{DD} = 4.0V$ , WDT disabled, $-40^{\circ}C$ to $+85^{\circ}C$
D021B			-	2.5	19	μA	VDD = 4.0V, WDT disabled, -40°C to +125°C
D023*	Brown-out Reset Current (Note 6)	$\Delta$ Ibor	-	350	425	μA	BOR enabled, VDD = 5.0V

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD

MCLR = VDD; WDT enabled/disabled as specified.

3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and VSS.

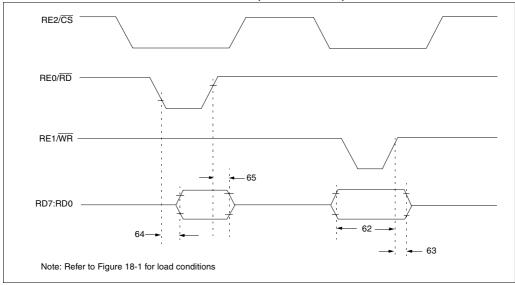
4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.

5: Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.

6: The ∆ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

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#### FIGURE 18-8: PARALLEL SLAVE PORT TIMING (PIC16C64A/R64)



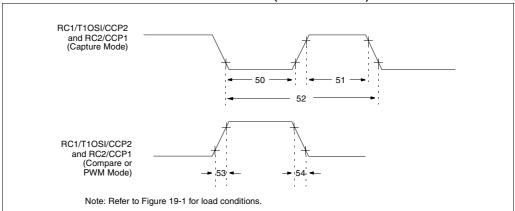
### TABLE 18-7: PARALLEL SLAVE PORT REQUIREMENTS (PIC16C64A/R64)

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions	
62	TdtV2wrH	Data in valid before $\overline{WR}\uparrow$ or $\overline{CS}\uparrow$ (setup time)		20	_	_	ns	
				25	_	-	ns	Extended Range Only
63*	TwrH2dtl	$\overline{WR}^{\uparrow}$ or $\overline{CS}^{\uparrow}$ to data–in invalid (hold	PIC16 <b>C</b> 64A/R64	20	—	—	ns	
		time)	PIC16 <b>LC</b> 64A.R64	35	_	—	ns	
64	TrdL2dtV	$\overline{RD}\downarrow$ and $\overline{CS}\downarrow$ to data–out valid		I	_	80	ns	
				—	_	90	ns	Extended Range Only
65*	TrdH2dtI	$\overline{\text{RD}}$ for $\overline{\text{CS}}$ to data-out invalid		10	_	30	ns	

These parameters are characterized but not tested.

Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not t tested.

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## FIGURE 19-6: CAPTURE/COMPARE/PWM TIMINGS (CCP1 AND CCP2)

TABLE 19-6: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP1 AND CCP2)

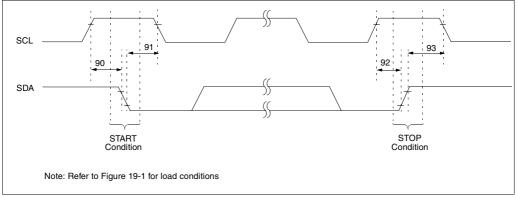
Parameter No.	Sym	Characteristic	:		Min	Тур†	Max	Units	Conditions
50*	TccL	CCP1 and CCP2	No Prescaler		0.5TCY + 20	—	_	ns	
		input low time	With Prescaler	PIC16 <b>C</b> 65	10	_		ns	
				PIC16 <b>LC</b> 65	20	—	-	ns	
51*	TccH	CCP1 and CCP2	No Prescaler		0.5Tcy + 20	_		ns	
		input high time	With Prescaler	PIC16 <b>C</b> 65	10	_		ns	
				PIC16 <b>LC</b> 65	20	—		ns	
52*	TccP	CCP1 and CCP2 in	CCP1 and CCP2 input period			_	I	ns	N = prescale value (1,4, or 16)
53	TccR	CCP1 and CCP2 of	CCP1 and CCP2 output rise time PIC16C65			10	25	ns	
		PIC16 <b>LC</b> 65			—	25	45	ns	
54	TccF	CCP1 and CCP2 output fall time PIC16		PIC16 <b>C</b> 65	—	10	25	ns	
				PIC16 <b>LC</b> 65	—	25	45	ns	

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

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## FIGURE 19-9: I<sup>2</sup>C BUS START/STOP BITS TIMING

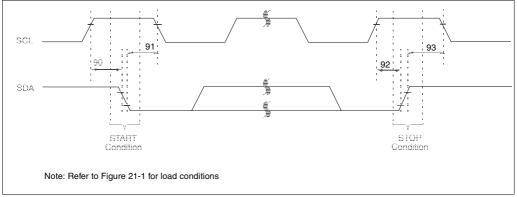


## TABLE 19-9: I<sup>2</sup>C BUS START/STOP BITS REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Тур	Мах	Units	Conditions
90	TSU:STA	START condition	100 kHz mode	4700	—	—	ns	Only relevant for repeated START
		Setup time	400 kHz mode	600	—		110	condition
91	THD:STA	START condition	100 kHz mode	4000	_	—	ns	After this period the first clock
		Hold time	400 kHz mode	600	—	_	115	pulse is generated
92	TSU:STO	STOP condition	100 kHz mode	4700	—	_	ns	
		Setup time	400 kHz mode	600	—	_	115	
93	THD:STO	STOP condition	100 kHz mode	4000	—	-	ns	
		Hold time	400 kHz mode	600	—	-	115	

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

## FIGURE 21-10: I<sup>2</sup>C BUS START/STOP BITS TIMING



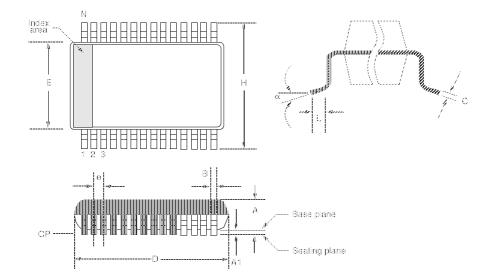
#### I<sup>2</sup>C BUS START/STOP BITS REQUIREMENTS **TABLE 21-9:**

Parameter No.	Sym	Characteristic		Min	Тур	Мах	Units	Conditions
90*	TSU:STA	START condition	100 kHz mode	4700	—	—	ns	Only relevant for repeated START
		Setup time	400 kHz mode	600	—	—	113	condition
91*	THD:STA	START condition	100 kHz mode	4000	—	—	ns	After this period the first clock
		Hold time	400 kHz mode	600	—	—	115	pulse is generated
92*	TSU:STO	STOP condition	100 kHz mode	4700	—	—	ns	
		Setup time	400 kHz mode	600	—	—	115	
93	THD:STO	STOP condition	100 kHz mode	4000	—	—	-	
		Hold time	400 kHz mode	600	—	—	ns	

These parameters are characterized but not tested.

## 24.10 28-Lead Plastic Surface Mount (SSOP - 209 mil Body 5.30 mm) (SS)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Package Group: Plastic SSOP										
		Millimeters		Inches							
Symbol	Min	Max	Notes	Min	Max	Notes					
α	0°	8°		0°	8°						
А	1.730	1.990		0.068	0.078						
A1	0.050	0.210		0.002	0.008						
В	0.250	0.380		0.010	0.015						
С	0.130	0.220		0.005	0.009						
D	10.070	10.330		0.396	0.407						
E	5.200	5.380		0.205	0.212						
е	0.650	0.650	Reference	0.026	0.026	Reference					
Н	7.650	7.900		0.301	0.311						
L	0.550	0.950		0.022	0.037						
Ν	28	28		28	28						
CP	-	0.102		-	0.004						

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